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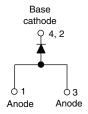
COMPLIANT

HALOGEN

FREE

High Performance Schottky Rectifier, 3.5 A





DPAK	(TO-2	252AA)
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PRIMARY CHARACTERISTICS					
I _{F(AV)}	3.5 A				
V_{R}	60 V				
V _F at I _F	See Electrical table				
I _{RM}	30 mA at 125 °C				
T _J max.	150 °C				
E _{AS}	6 mJ				
Circuit configuration	Single				
Package	DPAK (TO-252AA)				

FEATURES

- Low forward voltage drop
- Guard ring for enhanced ruggedness and long term reliability
- Popular D-PAK outline
- · Small foot print, surface mountable
- High frequency operation
- AEC-Q101 qualified
- Meets JESD 201 class 2 whisker test
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



The VS-30WQ06FNHM3 surface mount Schottky rectifier has been designed for applications requiring low forward drop and small foot prints on PC board. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

	h				
MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	VALUES	UNITS		
I _{F(AV)}	Rectangular waveform	3.5	А		
V _{RRM}		60	V		
I _{FSM}	$t_p = 5 \mu s sine$	490	Α		
V _F	3 A _{pk} , T _J = 125 °C	0.53	V		
T _J		-40 to +150	°C		

VOLTAGE RATINGS						
PARAMETER	SYMBOL	VS-30WQ06FNHM3	UNITS			
Maximum DC reverse voltage	V_{R}	60	V			
Maximum working peak reverse voltage	V_{RWM}	50	V			

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum average forward current See fig. 5	I _{F(AV)}	50 % duty cycle at T _C = 133 °C	3.5			
Maximum peak one cycle non-repetitive surge current	l=a	5 μs sine or 3 μs rect. pulse	rect. pulse Following any rated load condition and with rated		Α	
See fig. 7	I _{FSM}	10 ms sine or 6 ms rect. pulse	V _{RRM} applied	70		
Non-repetitive avalanche energy	E _{AS}	T _J = 25 °C, I _{AS} = 1 A, L = 12 mH		6.0	mJ	
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		1.0	Α	



ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
		3 A	T _{.1} = 25 °C	0.61	- V	
Maximum forward voltage drop	V _{FM} ⁽¹⁾	6 A	11 = 23 0	0.76		
See fig. 1	VFM (*)	3 A	T _{.1} = 125 °C	0.53		
		6 A	1j = 125 C	0.65		
Maximum reverse leakage current	I _{RM} ⁽¹⁾	T _J = 25 °C	V Datad V	2	- mA	
See fig. 2	'RM`'	T _J = 125 °C	V _R = Rated V _R	30		
Threshold voltage	V _{F(TO)}	T - T maximum		0.38	V	
Forward slope resistance	r _t	$T_J = T_J$ maximum		34.31	m $Ω$	
Typical junction capacitance	C _T	V _R = 5 V _{DC} (test signal range	145	pF		
Typical series inductance	L _S	Measured lead to lead 5 mm from package body		5.0	nH	
Maximum voltage rate of change	dV/dt	Rated V _R	10 000	V/µs		

Note

 $^{(1)}\,$ Pulse width < 300 µs, duty cycle < 2 %

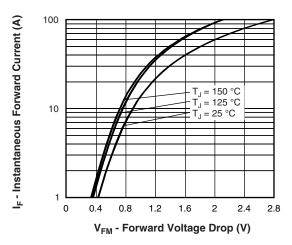
THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range	T _J ⁽¹⁾ , T _{Stg}		-40 to +150	°C	
Maximum thermal resistance, junction to case	R _{thJC}	DC operation See fig. 4	4.7	°C/W	
Approximate weight			0.3	g	
Approximate weight			0.01	OZ.	
Marking device		Case style DPAK (TO-252AA)	30WQ0	6FNH	

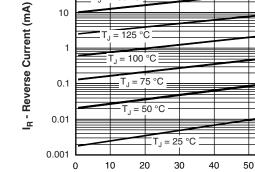
Note

$$\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}} \quad \text{thermal runaway condition for a diode on its own heatsink}$$



60





Γ_J = 150 °C

= 125

= 100 °C

100

10

Fig. 1 - Maximum Forward Voltage Drop Characteristics

V_R - Reverse Voltage (V) Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

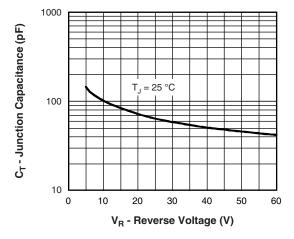


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

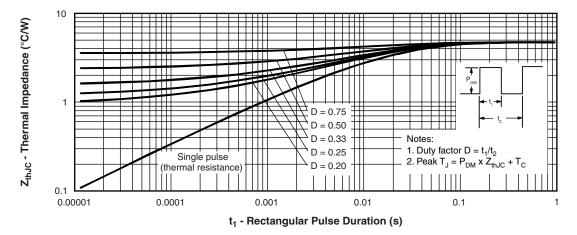


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics



Allowable Case Temperature (°C)

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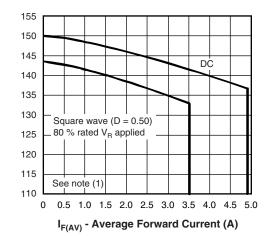


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

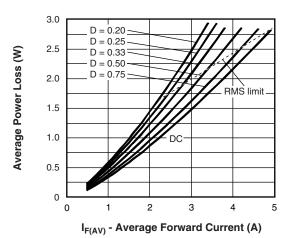


Fig. 6 - Forward Power Loss Characteristics

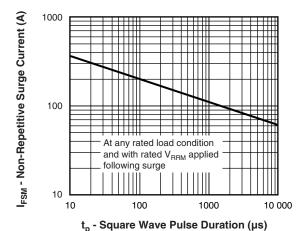


Fig. 7 - Maximum Non-Repetitive Surge Current

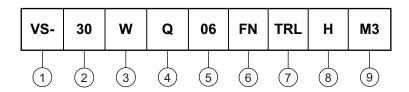
Note

(1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{th,JC}$; $Pd = forward power loss = I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} = inverse power loss = V_{R1} \times I_R (1 - D)$; I_R at $V_{R1} = 80$ % rated V_R



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

- Current rating (3.5 A)

3 - Package identifier:

W = DPAK

4 - Schottky "Q" series

- Voltage rating (06 = 60 V)

- FN = DPAK (TO-252AA)

7 - • None = tube

• TR = tape and reel

• TRL = tape and reel (left oriented)

• TRR = tape and reel (right oriented)

8 - H = AEC-Q101 qualified

9 - Environmental digit:

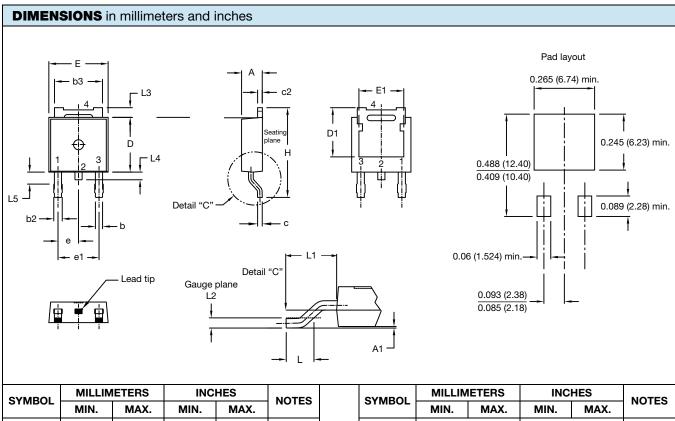
M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-30WQ06FNHM3	75	3000	Antistatic plastic tube			
VS-30WQ06FNTRHM3	2000	2000	13" diameter reel			
VS-30WQ06FNTRRHM3	3000	3000	13" diameter reel			
VS-30WQ06FNTRLHM3	3000	3000	13" diameter reel			

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95519			
Part marking information	www.vishay.com/doc?95518			
Packaging information	www.vishay.com/doc?95033			
SPICE model	www.vishay.com/doc?95687			



DPAK (TO-252AA)



SYMBOL	MILLIMETERS		INC	NOTES	
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	2.18	2.39	0.086	0.094	
A1	-	0.13	-	0.005	
b	0.64	0.89	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	3
С	0.46	0.61	0.018	0.024	
c2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	5
D1	4.93	-	0.194	-	3
Е	6.35	6.73	0.250	0.265	5
E1	4.32	-	0.170	-	3

SYMBOL	MILLIMETERS		INC	HES	NOTES
STIVIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
е	2.29 BSC 0.090 BSC				
Н	9.40	10.41	0.370	0.410	
L	1.40	1.78	0.055	0.070	
L1	2.74 BSC		0.108	REF.	
L2	0.51 BSC		0.020	BSC	
L3	0.89	1.27	0.035	0.050	3
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	2

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Dimensions D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (5) Outline conforms to JEDEC® outline TO-252AA, except for D1 dimension



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